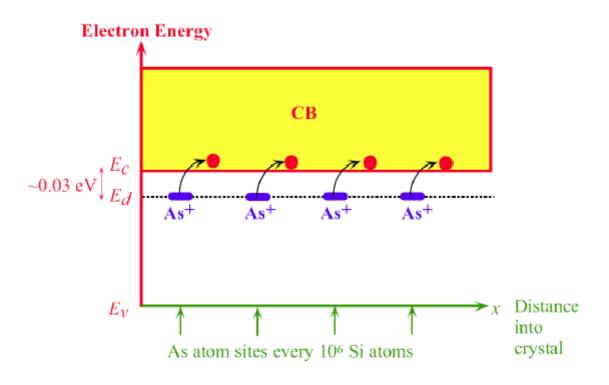


Arsenic-doped Si crystal.

The four valence electrons of As allow it to bond just like Si, but the fifth electron is left orbiting the As site. The energy required to release the free fifth electron into the CB is very small.



Energy band diagram for an n-type Si doped with 1 ppm As. There are donor energy levels just below E_c around As⁺ sites^{Fig 5.10}

From Principles of Electronic Materials and Devices, Third Edition, S.O. Kasap (© McGraw-Hill, 2005)

N-type Conductivity

$$\sigma = eN_d\mu_e + e\left(\frac{n_i^2}{N_d}\right)\mu_h \approx eN_d\mu_e \qquad 5.16$$

$$\sigma = eN_d\mu_e \qquad 5.16$$

e = electronic charge N_d = donor atom concentration in the crystal μ_e = electron drift mobility, n_i = intrinsic concentration, μ_b = hole drift mobility

Occupation Probability at a Donor

$$f_d(E_d) = \frac{1}{1 + \frac{1}{2} \exp\left[\frac{(E_d - E_F)}{kT}\right]}$$
 5.17

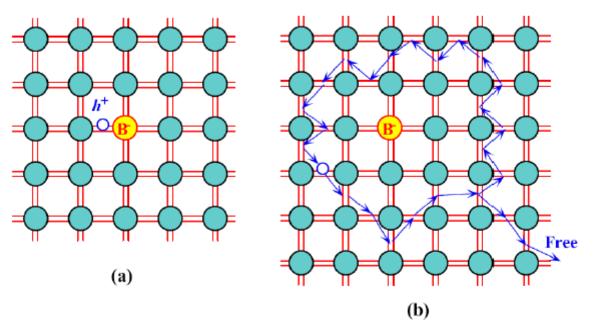
 $f_d(E_d)$ = probability of finding an electron in a state with energy E_d at a donor

 E_d = energy level of donor

½ comes from the fact that donor

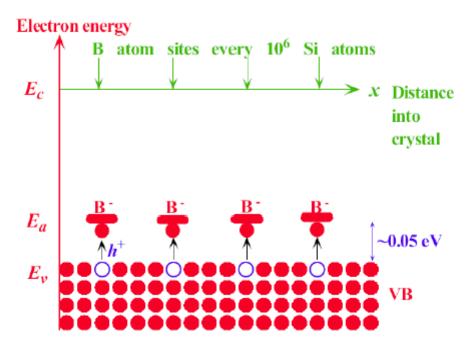
can only take one electron

From Principles of Electronic Materials and Devices, Third Edition, S.O. Kasap (© McGraw-Hill, 2005)



Boron-doped Si crystal.

B has only three valence electrons. When it substitutes for a Si atom, one of its bonds has an electron missing and therefore a hole, as shown in (a). The hole orbits around the B site by the tunneling of electrons from neighboring bonds, as shown in (b). Eventually, thermally vibrating Si atoms provide enough energy to free the hole from the B site into the VB, as shown.



Energy band diagram for a p-type Si doped with 1 ppm B. There are acceptor energy levels E_a just above E_v around B⁻ sites. These acceptor levels accept electrons from the VB and therefore create holes in the VB.

From Principles of Electronic Materials and Devices, Third Edition, S.O. Kasap (© McGraw-Hill, 2005)

P-type Conductivity

$$\sigma = eN_a\mu_h + e\left(\frac{n_i^2}{N_a}\right)\mu_e \approx eN_a\mu_h$$

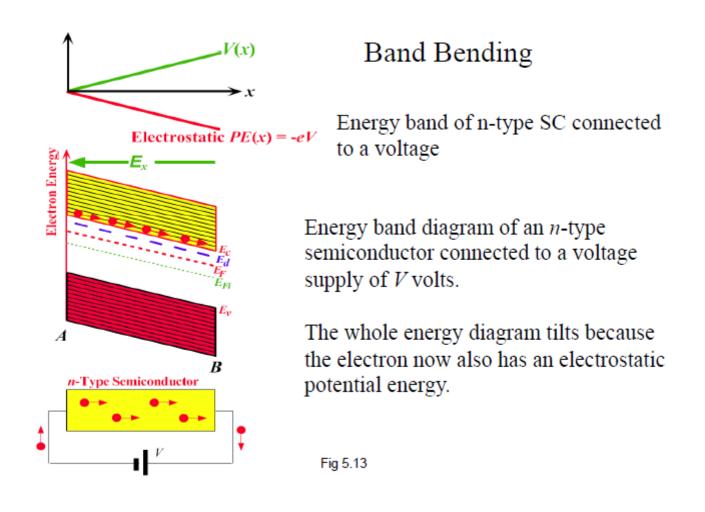
$$\sigma = eN_a\mu_h$$

e = electronic charge N_a = acceptor atom concentration in the crystal μ_h = hole drift mobility, n_i = intrinsic concentration, μ_e = electron drift mobility

Table 5.2 Examples of donor and acceptor ionization energies (eV) in Si

| Donors | | | Acceptors | | |
|--------|-------|-------|-----------|-------|-------|
| P | As | Sb | В | Al | Ga |
| 0.045 | 0.054 | 0.039 | 0.045 | 0.057 | 0.072 |

For donors it is energy below CB For acceptors it is energy above VB



Compensation Doping

More donors than acceptors $N_d - N_a >> n_i$

$$N_d - N_a >> n$$

$$n = N_d - N_a$$

$$n = N_d - N_a$$
 $p = \frac{n_i^2}{n} = \frac{n_i^2}{N_d - N_a}$

More acceptors than donors $N_a - N_d >> n_i$

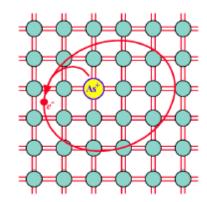
$$N_a - N_d >> n_i$$

$$p = N_a - N_d$$

$$p = N_a - N_d$$
 $n = \frac{n_i^2}{p} = \frac{n_i^2}{N_a - N_d}$

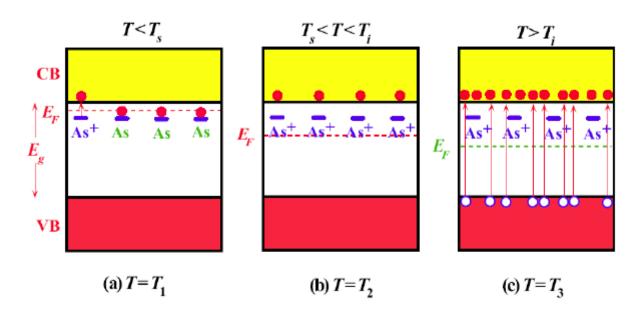
Binding energy of electron in H-atom

$$E_b = -E_1 = \frac{m_e^* e^4}{8\varepsilon_o^2 h^2} = 13.6 \text{ eV}$$



$$E_b^{Si} = \frac{m_e^* e^4}{8\varepsilon_o^2 \varepsilon_r^2 h^2} = 13.6 \text{ eV}(\frac{m_e^*}{m_e})(\frac{1}{\varepsilon_r^2})$$

For Si
$$\varepsilon_r = 11.9$$
 and $\frac{m_e^*}{m_e} = \frac{1}{3}$ so $E_b^{Si} \approx 0.032 eV$



- (a) Below T_s , the e⁻¹ conc. is controlled by the ionization of the donors.
- (b) Between T_s and T_i , the e⁻¹ conc. = concentration of donors since they would all have ionized.
- (c) At high T, thermally generated electrons from the VB exceed the # # of e⁻¹ from ionized donors and the SC behaves as if intrinsic.

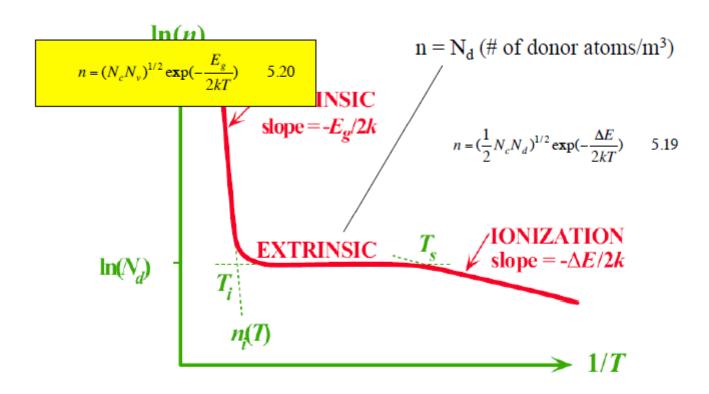
5.3.1 Carrier Concentration

Low Temperature Regime:

$$n = (\frac{1}{2}N_c N_d)^{1/2} \exp(-\frac{\Delta E}{2kT})$$
 5.19

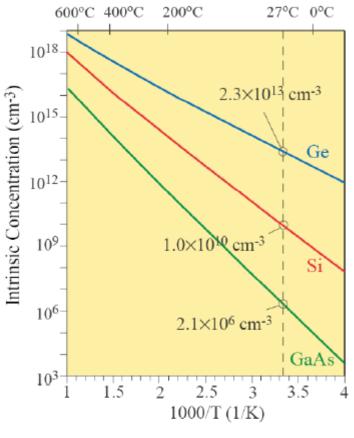
Compare to intrinsic case:

$$n = (N_c N_v)^{1/2} \exp(-\frac{E_g}{2kT})$$
 5.20



The temperature dependence of the electron <u>concentration</u> in an n-type semiconductor.

Fig 5.15



The temperature dependence of the intrinsic concentration

Fig 5.16

From Principles of Electronic Materials and Devices, Third Edition, S.O. Kasap (@ McGraw-Hill, 2005)

5.3.2 Drift Mobility and Impurity Dependence

$$\mu = \frac{e\tau}{m_e^*} \qquad 5.21$$

$$\tau = \frac{1}{Sv_{th}N_S}$$
 5.22

S is the cross-section area of the scatters, v_{th} = mean speed of electrons, aka as thermal velocity N_s is number of scatters per unit volume.

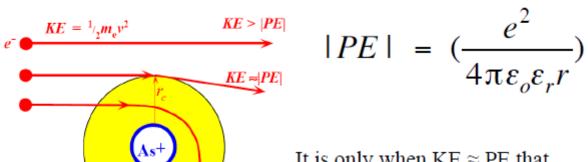
$$S = \pi a^2 \qquad \frac{1}{2} m_e^* v_{th}^2 = \frac{3}{2} kT$$

Lattice Vibration Scattering Limited Mobility

$$\tau_L = \frac{1}{(\pi a^2) v_{th} N_S} \quad \alpha \quad \frac{1}{(T)(T^{1/2})} \quad \alpha \quad T^{-3/2}$$

$$\tau_L \alpha T^{-3/2}$$
 5.23

Scattering of electrons by an ionized impurity.



It is only when $KE \approx PE$ that electron will get scattered. So

$$3/2kT = |PE(r_c)| = (\frac{e^2}{4\pi\varepsilon_o\varepsilon_r r_c})$$

$$r_c = \frac{e^2}{6\pi\varepsilon_o\varepsilon_r kT} \qquad S = \pi r_c^2 = \frac{\pi e^4}{(6\pi\varepsilon_o\varepsilon_r kT)^2} \alpha T^{-2}$$

Ionized Impurity Scattering Limited Mobility

$$\tau_L = \frac{1}{S v_{th} N_I} \quad \alpha \quad \frac{1}{(T^{-2})(T^{1/2}) N_I} \quad \alpha \quad \frac{T^{3/2}}{N_I}$$

$$\mu_I \propto \frac{T^{-3/2}}{N_I} \qquad 5.24$$

 μ_I = ionized impurity scattering limited mobility

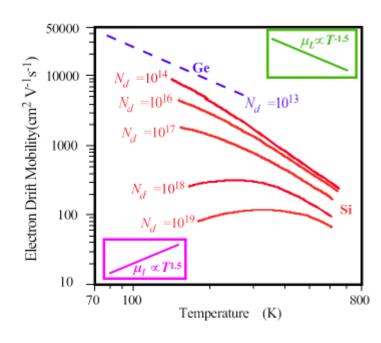
Effective or Overall Mobility

$$\frac{1}{\mu_e} = \frac{1}{\mu_I} + \frac{1}{\mu_L}$$
 5.25

 μ_e = effective drift mobility

 μ_I = ionized impurity scattering limited mobility

 μ_L = lattice vibration scattering limited mobility

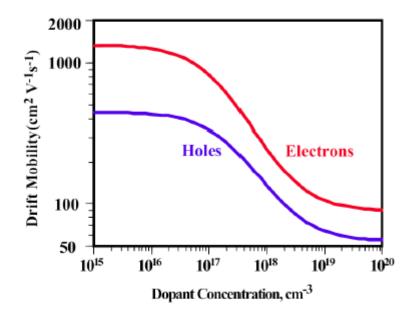


Lets look at experimental results. Note LOG-LOG

In English: At the lowest T, increasing the T increases the v_{th} of electrons so as to not be affected by impurities.

BUT, further increases in T causes the atoms to vibrate more and scatter more. So mobility decreases again.

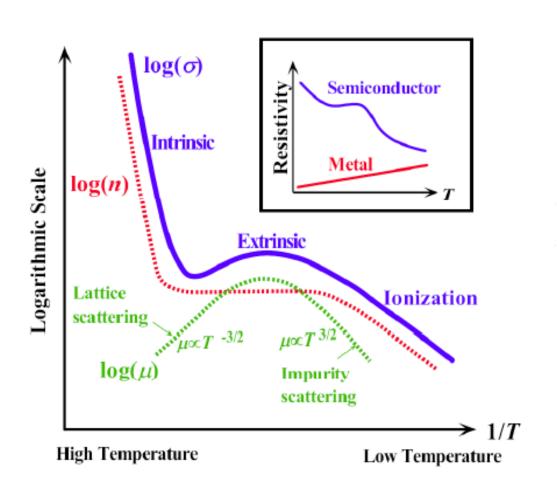
Log-log plot of drift mobility versus temperature for n-type Ge and n-type Si samples. Various donor concentrations for Si are shown. N_d are in cm⁻³. The upper right inset is the simple theory for lattice limited mobility, whereas the lower left inset is the simple theory for impurity scattering limited mobility.



More LOG-LOG experimental results

Increasing the dopant concentration is NOT good for mobility!

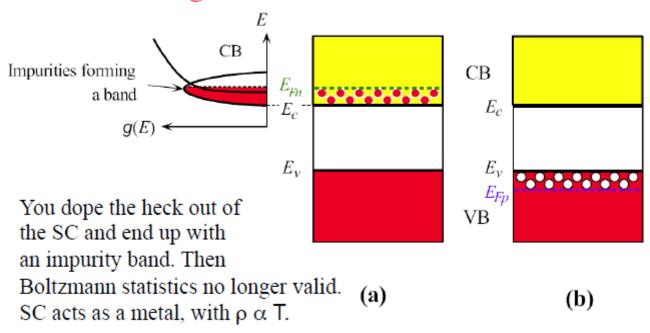
The variation of the drift mobility with dopant concentration in Si for electrons and holes at 300 K.



For n-type extrinsic SC

- At very low temperatures the conductivity is quite low because there are few electrons in the CB. Impurity atoms are holding on to their electrons.
- At intermediate temperatures, all the dopant atoms donate their electrons to CB and conductivity saturates.
- At very high temperatures, the conductivity is very high because Si-Si bonds are being broken.
- •Mobilities depend on dopant concentration. For low dopant concentrations mobility is only affected by phonons.
- •When dopant concentrations are high they can trap electrons at lower temperatures. The trapping probability, however, deceases with increasing T.
- •All these conclusions apply to p-type SC as well.

Degenerate Semiconductors



- (a) Degenerate n-type SC. Large number of donors form a band that overlaps the CB.
- (b) Degenerate p-type semiconductor.